## MAXIMUM SOLUTIONS

## Mill-Max Micro-Miniature Organic Fibre Plug® Receptacle



Mill-Max has added a micro-miniature option to our organic fibre plug<sup>®</sup> receptacle lineup. The newest Mill-Max socket receptacle, 4428-0-43-15-04-14-10-0, is our tiniest OFP<sup>®</sup> receptacle ever. Optimized for high-density packaging down to 1 mm pitch, this micro-miniature, ultra-low profile receptacle accepts .008"-.013" device leads or mating pins and can be soldered into a hole as small as .030."

Mill-Max's Organic Fibre Plug (OFP<sup>®</sup>) solder barrier receptacles are discrete sockets for through-hole soldering into printed circuit boards. These open bottom receptacles are fitted with Organic Fibre Plugs<sup>®</sup> to prevent contamination of the internal contact during the soldering process. When the device/mating lead is plugged into the receptacle, the OFP<sup>®</sup> is knocked out, allowing the mating lead to pass through the fingers of the internal contact and make a reliable electrical connection. Like all Mill-Max OFP<sup>®</sup> receptacles, the 4428 features an open bottom construction designed for pin pass-through requirements such as board-to-board or board to module interconnection.

The 4428 is also available packaged on tape & reel, part number 4428-0-67-15-04-14-10-0. Tape & reel packaging permits these through-hole components to be placed simultaneously with surface mount parts on pick-'n-place assembly lines – eliminating the need to hand place the receptacles in an additional manufacturing step.

Mill-Max 4428 features a gold plated, precision-machined brass shell assembled with our exclusive #04 gold plated beryllium copper contact clip with a 2 amp current rating.

For more information, please visit: www.mill-max.com/PR630.

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## PIN RECEPTACLES With Organic Fibre Plug<sup>®</sup> Solder Barrier (see specific contact range on pages 216, 217 & 219)



- These through-hole (tubular) receptacles are designed for hand, wave or reflow\* soldering. The *ORGANIC FIBRE PLUG*® barrier prevents solder, paste or flux from contaminating the spring contact.
- After soldering, the  $OFP^{\mathbb{R}}$  barrier is pushed out of the receptacle when the device is plugged in.
- All parts are available as discrete receptacles; but for SMT assembly, certain receptacles are supplied on carrier tape per EIA-481 to feed industry standard pick and place machines.

\*Intrusive reflow (also called "pin-in-paste") is a technique of using conventional through-hole components in a reflow soldering process. The receptacles are placed into plated through-holes in the circuit board (solder paste has previous-



Is been screen printed on pads adjacent to the holes) and the board is reflowed in the same pass as other SMT components. Solder will fill the plated through-holes and achieve solder joints as reliable as wave soldering. The OFP<sup>®</sup> barrier prevents solder paste from being picked-up inside the contact during pick 'n place assembly. "Overprinting" paste on the solder mask can be used to adjust the volume of paste required to fill each hole.

